

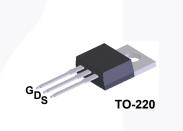
FQP13N10 N-Channel QFET[®] MOSFET 100 V, 12.8 A, 180 mΩ

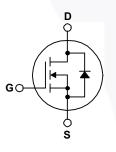
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 12.8 A, 100 V, ${\sf R}_{{\sf DS}({\sf on})}$ = 180 m Ω (Max.) @ V_{{\sf GS}} = 10 V, ${\sf I}_{{\sf D}}$ = 6.4 A
- Low Gate Charge (Typ. 12 nC)
- Low Crss (Typ. 20 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

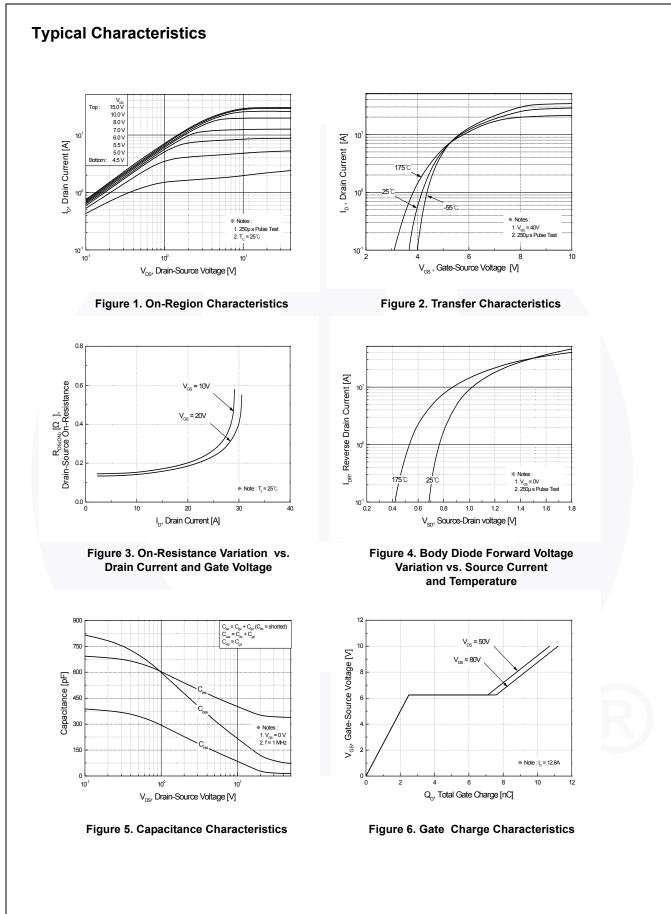
Symbol	Parameter		FQP13N10	Unit
V _{DSS}	Drain-Source Voltage	100	V	
D	Drain Current - Continuous (T _C = 25°C)	12.8	A	
	- Continuous (T _C = 100°C)	_	9.05	A
I _{DM}	Drain Current - Pulsed	(Note 1)	51.2	A
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	95	mJ
AR	Avalanche Current	(Note 1)	12.8	A
E _{AR}	Repetitive Avalanche Energy	(Note 1)	6.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.0	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)		65	W
	- Derate above 25°C	0.43	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

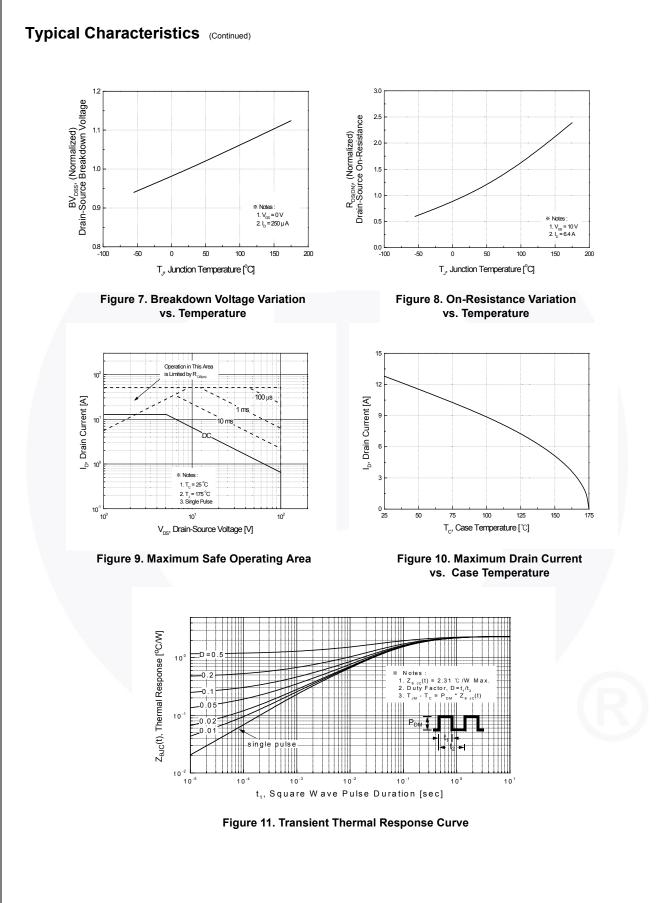
Thermal Characteristics

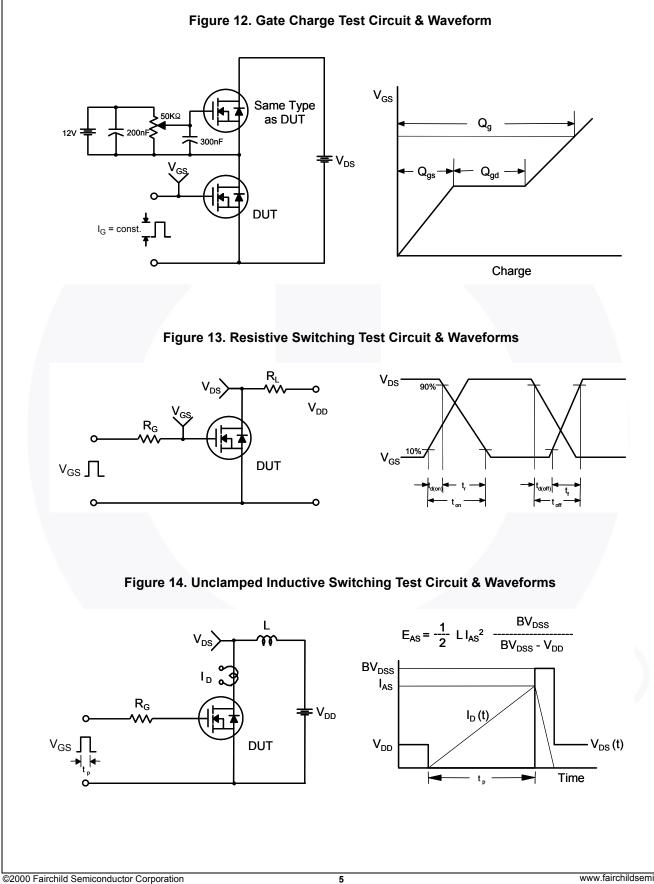
Symbol	Parameter	FQP13N10	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.31	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	°C/W

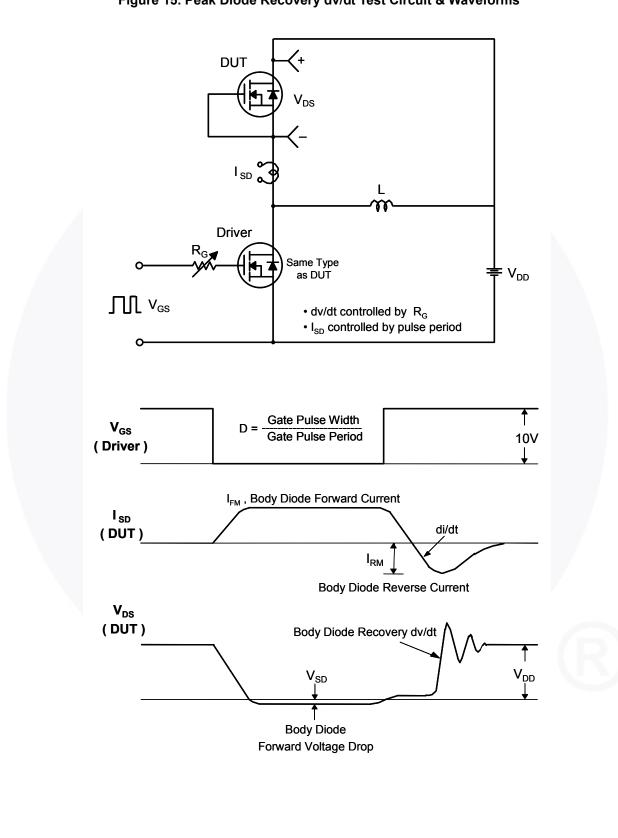
November 2013

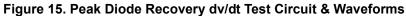
		Package	Packing Method	Reel Size	Tape Width		n Qi	Quantity	
		TO-220	Tube N/A		N/A		50 units		
lectri	cal Chara	acteristics _{Tc}	= 25°C unless other	wise noted.					
Symbol		Parameter		Test Condit	ions	Min	Тур	Max	Unit
Off Cha	aracteristic	'S							
BV _{DSS}		ce Breakdown Voltage		V _{GS} = 0 V, I _D = 250 J	ιA	100			V
ΔBV _{DSS}		Voltage Temperature C	oefficient	$I_D = 250 \mu$ A, Referenced to 25°C			0.09		V/°C
I _{DSS}	Zero Gate Voltage Drain Current		V _{DS} = 100 V, V _{GS} = 0 V				1	μA	
			$V_{DS} = 80 \text{ V}, \text{ T}_{C} = 150^{\circ}\text{C}$				10	μΑ	
GSSF	Gate-Body	Leakage Current, Forw	ard	V _{GS} = 25 V, V _{DS} = 0				100	nA
GSSR	Gate-Body	Leakage Current, Reve	rse	V_{GS} = -25 V, V_{DS} = 0	V			-100	nA
On Cha	racteristic	rs.							
V _{GS(th)}	1	hold Voltage		V _{DS} = V _{GS} , I _D = 250	μA	2.0		4.0	V
R _{DS(on)}	Static Drain On-Resista			V _{GS} = 10 V, I _D = 6.4	A		0.142	0.18	Ω
9 _{FS}	Forward Tra	ansconductance		V _{DS} = 40 V, I _D = 6.4	A		6.8		S
-		·							
	ic Charact						0.15	450	-
Ciss	Input Capac			$V_{DS} = 25 V, V_{GS} = 0 V,$ f = 1.0 MHz			345	450	pF
C _{oss}	Output Cap						100	130	pF
C _{rss}	Reverse IIa	ansfer Capacitance					20	25	pF
Switchi	ing Charad	cteristics							
t _{d(on)}	Turn-On De	lay Time		V_{DD} = 50 V, I _D = 12.8 A, R_{G} = 25 Ω (Note 4)			5	20	ns
ŕ	Turn-On Ris	se Time					55	120	ns
t _{d(off)}	Turn-Off De	lay Time					20	50	ns
^l f	Turn-Off Fa	ll Time					25	60	ns
Qg	Total Gate (Charge		V_{DS} = 80 V, I _D = 12.8 A, V _{GS} = 10 V			12	16	nC
Q _{gs}	Gate-Sourc	e Charge					2.5		nC
ପୁ _{gd}	Gate-Drain	Charge			(Note 4)		5.1		nC
Drain S		de Characteristic	e and Maxi	mum Potings					
s								12.8	Α
S SM	Maximum Continuous Drain-Source Diode Forwar Maximum Pulsed Drain-Source Diode Forward Cu							51.2	A
sm / _{SD}			V _{GS} = 0 V, I _S = 12.8	A		-	1.5	V	
rr m		covery Time	3~	$V_{GS} = 0 V, I_S = 12.8 A,$ $V_{GS} = 0 V, I_S = 12.8 A,$			72		ns
ייי גיי		covery Charge		$dI_{\rm F} / dt = 100 {\rm A}/{\rm \mu s}$,		0.17		μC
									µ 0

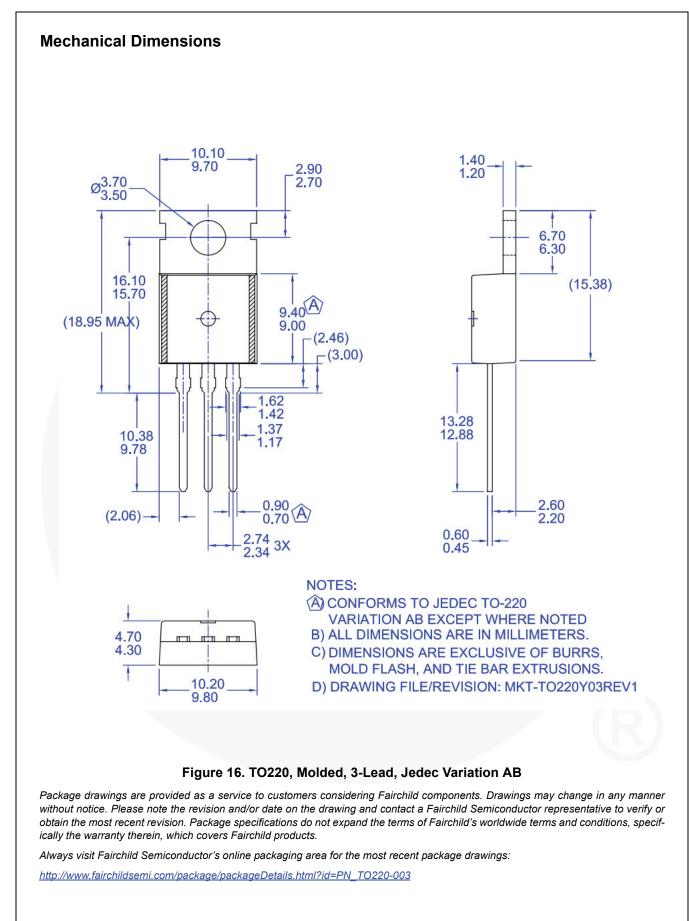














TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™ AX-CAP [®] *	F-PFS™ FRFET®	O®
BitSiC™	Global Power Resource SM	PowerTrench [®]
Build it Now™	GreenBridge™	PowerXS™
CorePLUS™	Green FPS™	Programmable Active Droop™
CorePOWER™	Green FPS™ e-Series™	QFET®
CROSSVOLT™	Gmax™	QS™
CTL™	GTO™	Quiet Series™
Current Transfer Logic™	IntelliMAX™	RapidConfigure™
DEUXPEED®	ISOPLANAR™	
Dual Cool™	Marking Small Speakers Sound Louder	
EcoSPARK®	and Better™	Saving our world, 1mW/W/kW at a t
EfficentMax™	MegaBuck™	SignalWise™
ESBC™	MICROCOUPLER™	SmartMax™
R	MicroFET™	SMART START™
	MicroPak™ MicroPako™	Solutions for Your Success™ SPM [®]
Fairchild®	MicroPak2™ MillerDrive™	
Fairchild Semiconductor®	MotionMax [™]	STEALTH™ SuperFET [®]
FACT Quiet Series™	mWSaver®	SuperSOT™-3
FACT®	OptoHiT™	SuperSOT ™-6
FAST [®] FastvCore™	OPTOLOGIC®	SuperSOT™-8
FETBench™	OPTOPLANAR®	SupreMOS [®]
FETBench™ FPS™		SyncFET™
		- , = .

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Sync-Lock™ SYSTEM^{®*} GENERAL

TinyBoost

TinyBuck® TinyCalc™ TinvLogic® TINYOPTO™

TinvPower™

TinyPWM™

TinyWire™

TranSiC™

Ultra FRFET™

VisualMax™

VoltagePlus™

UHC®

VCX™

XS™

UniFFT™

TriFault Detect™

TRUECURRENT®* µSerDes™

time™

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.



Authorized Distribution Brand :



Website :

Welcome to visit www.ameya360.com

Contact Us :

➤ Address :

401 Building No.5, JiuGe Business Center, Lane 2301, Yishan Rd Minhang District, Shanghai , China

- > Sales :
 - Direct +86 (21) 6401-6692
 - Email amall@ameya360.com
 - QQ 800077892
 - Skype ameyasales1 ameyasales2

> Customer Service :

Email service@ameya360.com

> Partnership :

Tel +86 (21) 64016692-8333

Email mkt@ameya360.com